

AOW292 Datasheet



DiGi Electronics Part Number	AOW292-DG
Manufacturer	Alpha & Omega Semiconductor Inc.
Manufacturer Product Number	AOW292
Description	MOSFET N-CH 100V 105A TO262
Detailed Description	N-Channel 100 V 14.5A (Ta), 105A (Tc) 1.9W (Ta), 300W (Tc) Through Hole TO-262

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Purchase and inquiry

Manufacturer Product Number:		Manufacturer:	
AOW292		Alpha & Omega Semiconductor Inc.	
Series:		Product Status:	
-		Obsolete	
FET Type:		Technology:	
N-Channel		MOSFET (Metal Oxide)	
Drain to Source Voltage (Vdss):		Current - Continuous Drain (Id) @ 25°C:	
100 V		14.5A (Ta), 105A (Tc)	
Drive Voltage (Max Rds On, Min Rds On):		Rds On (Max) @ Id, Vgs:	
10V		4.1mOhm @ 20A, 10V	
Vgs(th) (Max) @ Id:		Gate Charge (Qg) (Max) @ Vgs:	
3.4V @ 250µA		126 nC @ 10 V	
Vgs (Max):		Input Capacitance (Ciss) (Max) @ Vds:	
±20V		6775 pF @ 50 V	
FET Feature:		Power Dissipation (Max):	
-		1.9W (Ta), 300W (Tc)	
Operating Temperature:		Mounting Type:	
-55°C ~ 175°C (Tj)		Through Hole	
Supplier Device Package:		Package / Case:	
TO-262		TO-262-3 Long Leads, I2PAK, TO-262AA	
Base Product Number:			
AOW29			

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	



ALPHA & OMEGA
SEMICONDUCTOR

AOW292
100V N-Channel MOSFET

General Description

- Trench Power MV MOSFET technology
- Low $R_{DS(ON)}$
- Low Gate Charge
- Optimized for fast-switching applications

Applications

- Synchronous Rectification in DC/DC and AC/DC Converters
- Industrial and Motor Drive applications

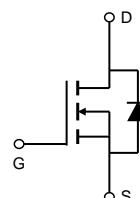
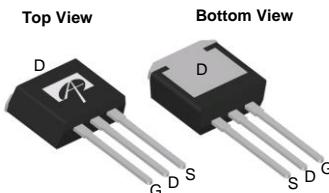
Product Summary

V_{DS}	100V
I_D (at $V_{GS}=10V$)	105A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	< 4.1mΩ
$R_{DS(ON)}$ (at $V_{GS}=6V$)	< 4.9mΩ

100% UIS Tested
100% R_g Tested



TO-262



Orderable Part Number	Package Type	Form	Minimum Order Quantity
AOW292	TO-262	Tube	1000

Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current ^G	I_D	105	A
$T_C=100^\circ C$		105	
Pulsed Drain Current ^C	I_{DM}	420	A
Continuous Drain Current	I_{DSM}	14.5	A
$T_A=70^\circ C$		11.5	
Avalanche Current ^C	I_{AS}	60	A
Avalanche energy $L=0.1\text{mH}$ ^C	E_{AS}	180	mJ
V_{DS} Spike ^I	10μs	V_{SPIKE}	V
Power Dissipation ^B	P_D	300	W
$T_C=100^\circ C$		150	
Power Dissipation ^A	P_{DSM}	1.9	W
$T_A=70^\circ C$		1.2	
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 175	°C

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	15	20	°C/W
Maximum Junction-to-Ambient ^{A,D} Steady-State		55	65	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.35	0.5	°C/W

**Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\mu\text{A}, V_{GS}=0\text{V}$	100			V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=100\text{V}, V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$		1	5	μA
I_{GSS}	Gate-Body leakage current	$V_{DS}=0\text{V}, V_{GS}=\pm20\text{V}$			±100	nA
$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	2.3	2.8	3.4	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS}=10\text{V}, I_D=20\text{A}$ $T_J=125^\circ\text{C}$		3.3	4.1	$\text{m}\Omega$
		$V_{GS}=6\text{V}, I_D=20\text{A}$		5.4	6.7	
g_{FS}	Forward Transconductance	$V_{DS}=5\text{V}, I_D=20\text{A}$		90		S
V_{SD}	Diode Forward Voltage	$I_S=1\text{A}, V_{GS}=0\text{V}$		0.68	1	V
I_S	Maximum Body-Diode Continuous Current ^G				105	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	$V_{GS}=0\text{V}, V_{DS}=50\text{V}, f=1\text{MHz}$		6775		pF
C_{oss}	Output Capacitance			557		pF
C_{rss}	Reverse Transfer Capacitance			32		pF
R_g	Gate resistance	$f=1\text{MHz}$	0.4	0.8	1.2	Ω
SWITCHING PARAMETERS						
$Q_g(10\text{V})$	Total Gate Charge	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, I_D=20\text{A}$		90	126	nC
Q_{gs}	Gate Source Charge			24		nC
Q_{gd}	Gate Drain Charge			13.5		nC
$t_{D(\text{on})}$	Turn-On Delay Time	$V_{GS}=10\text{V}, V_{DS}=50\text{V}, R_L=2.5\Omega, R_{\text{GEN}}=3\Omega$		20		ns
t_r	Turn-On Rise Time			11.5		ns
$t_{D(\text{off})}$	Turn-Off Delay Time			48		ns
t_f	Turn-Off Fall Time			10		ns
t_{rr}	Body Diode Reverse Recovery Time	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		50		ns
Q_{rr}	Body Diode Reverse Recovery Charge	$I_F=20\text{A}, dI/dt=500\text{A}/\mu\text{s}$		380		nC

A. The value of R_{JJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The Power dissipation P_{DSM} is based on $R_{\text{JJA}} \leq 10\text{s}$ and the maximum allowed junction temperature of 150°C . The value in any given application depends on the user's specific board design, and the maximum temperature of 175°C may be used if the PCB allows it.

B. The power dissipation P_0 is based on $T_{J(\text{MAX})}=175^\circ\text{C}$, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Single pulse width limited by junction temperature $T_{J(\text{MAX})}=175^\circ\text{C}$.

D. The R_{JJA} is the sum of the thermal impedance from junction to case R_{JJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using $<300\mu\text{s}$ pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of $T_{J(\text{MAX})}=175^\circ\text{C}$. The SOA curve provides a single pulse rating.

G. The maximum current rating is package limited.

H. These tests are performed with the device mounted on 1 in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$.

I. $L=100\mu\text{H}$, $F_{sw}=1\text{Hz}$, $T_J \leq 150^\circ\text{C}$ by repetitive UIS.

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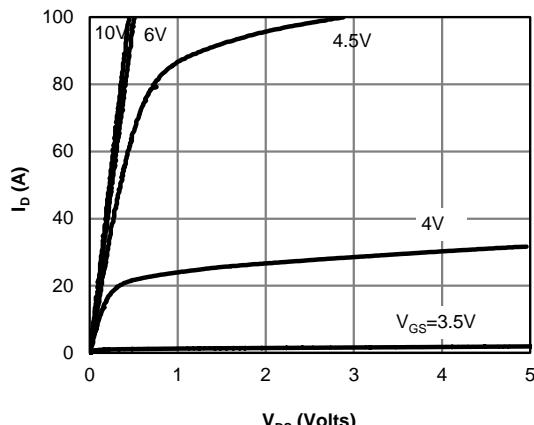
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 1: On-Region Characteristics (Note E)

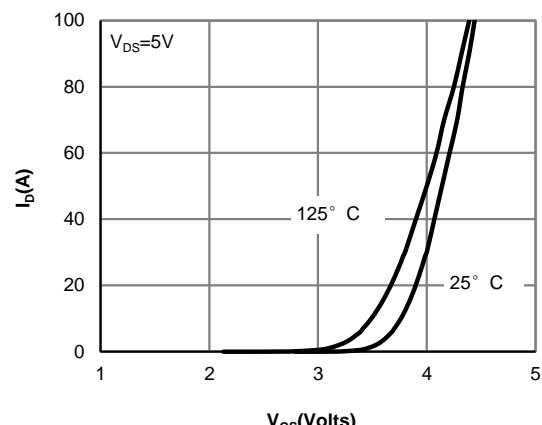


Figure 2: Transfer Characteristics (Note E)

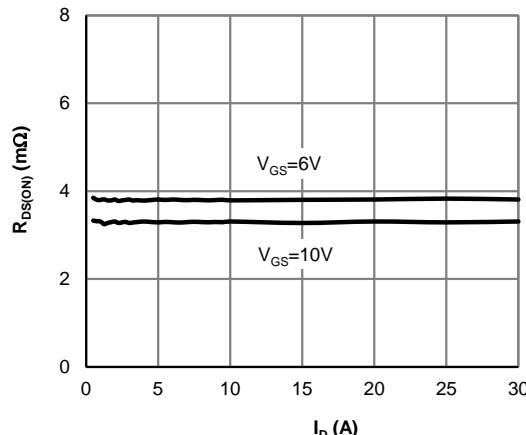


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

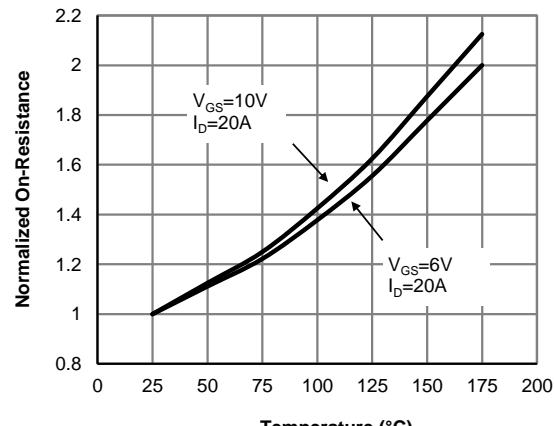


Figure 4: On-Resistance vs. Junction Temperature (Note E)

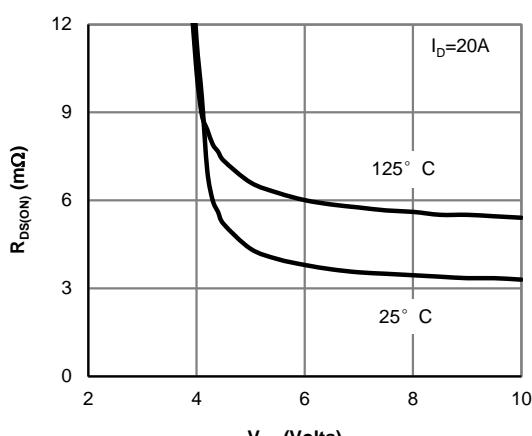


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

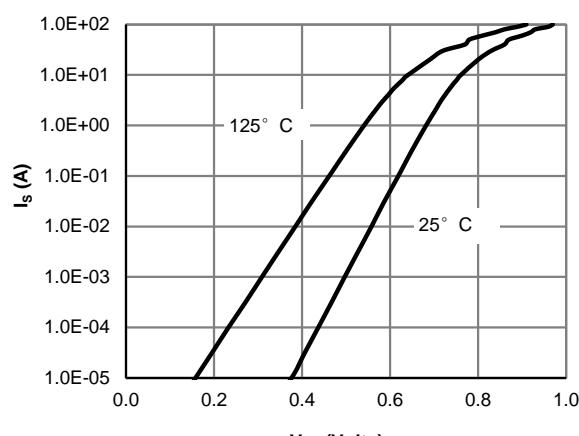
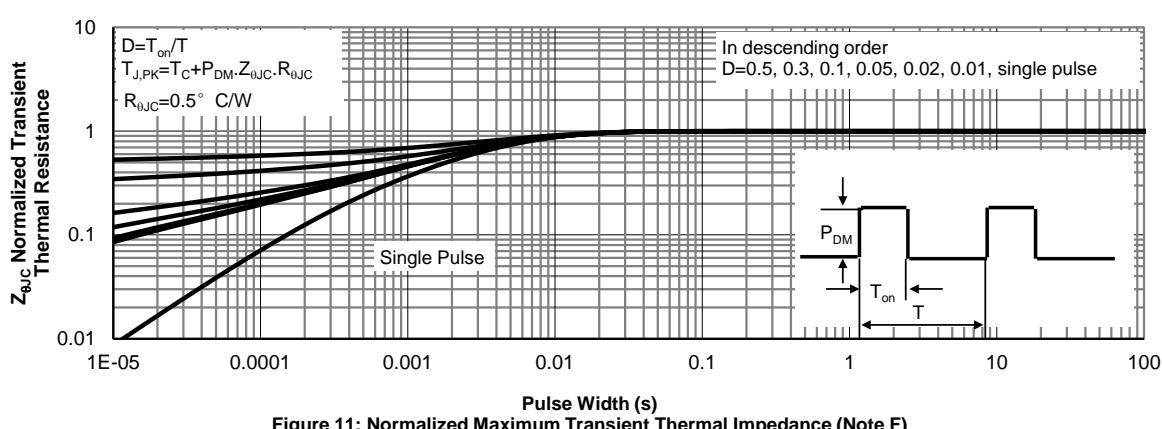
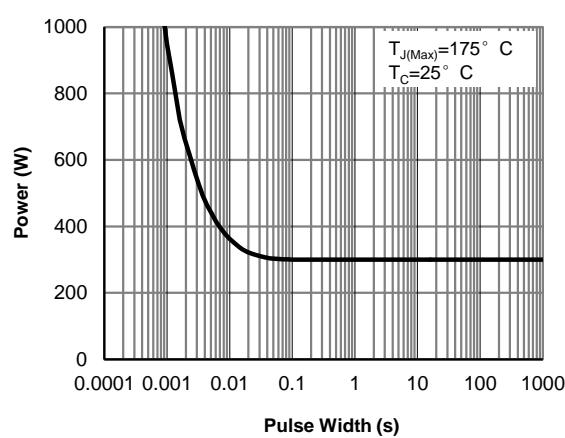
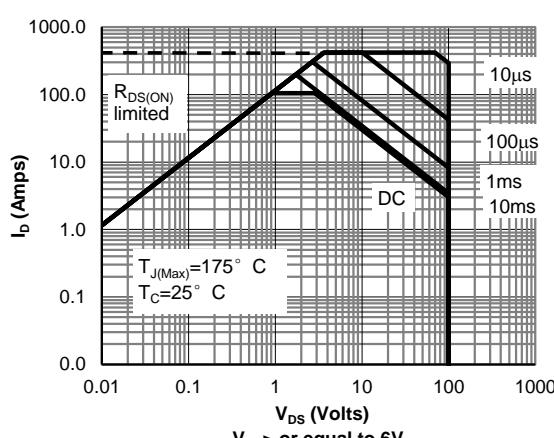
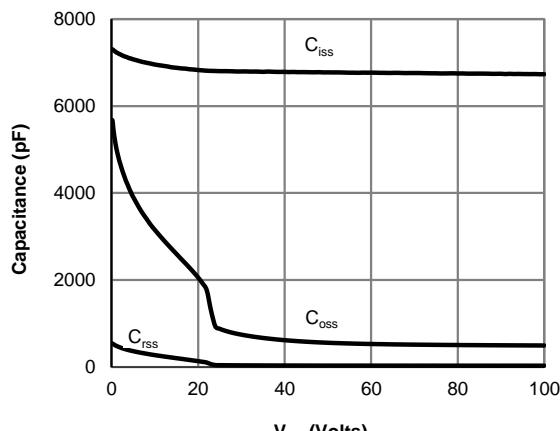
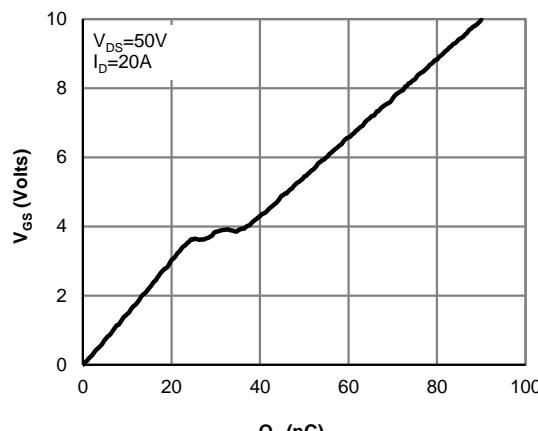
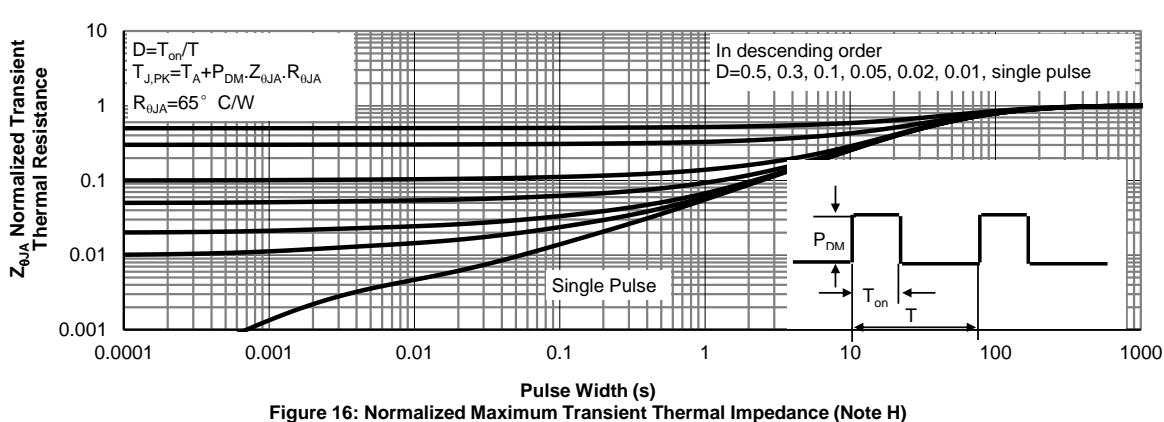
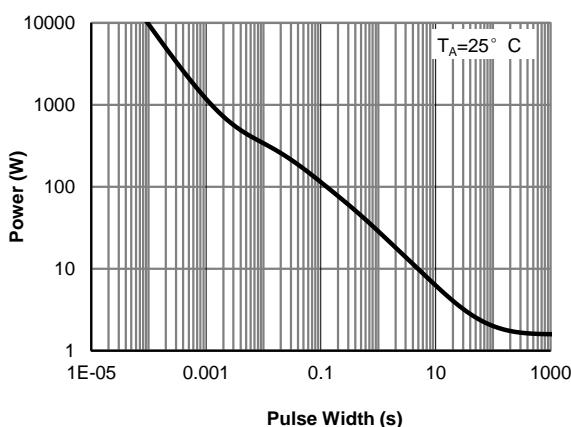
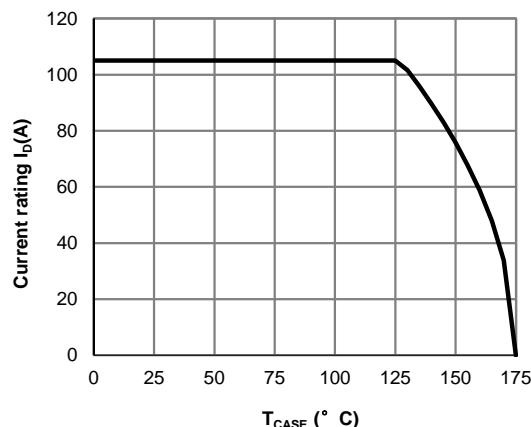
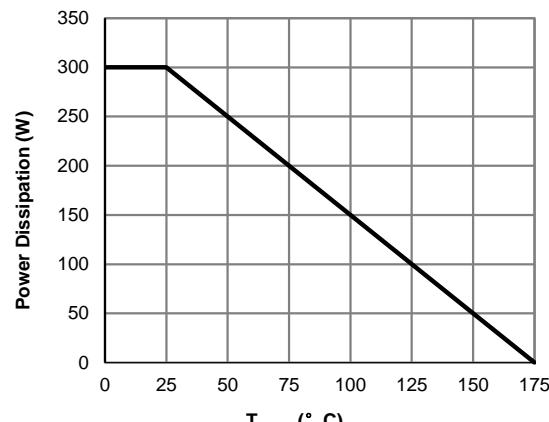
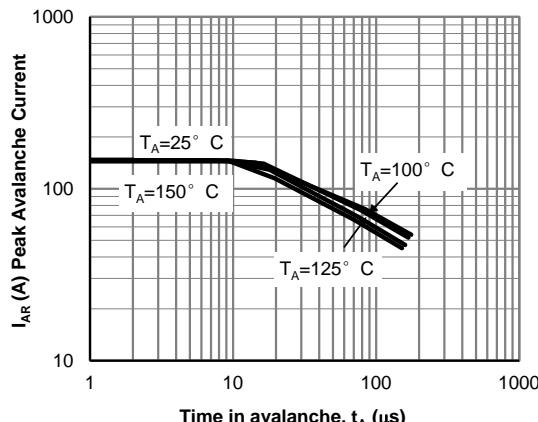
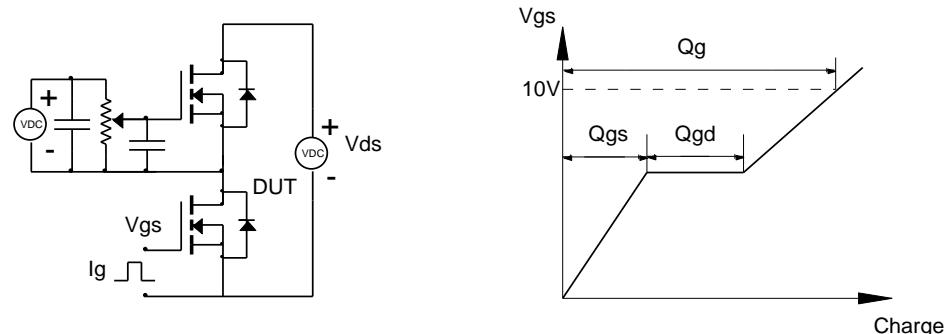
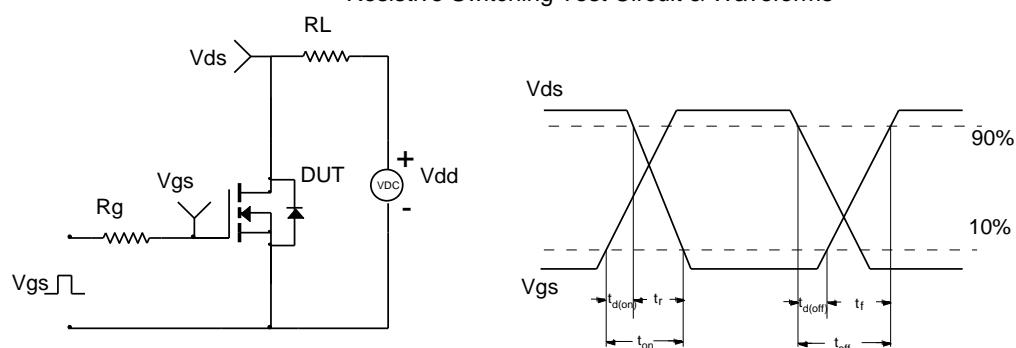
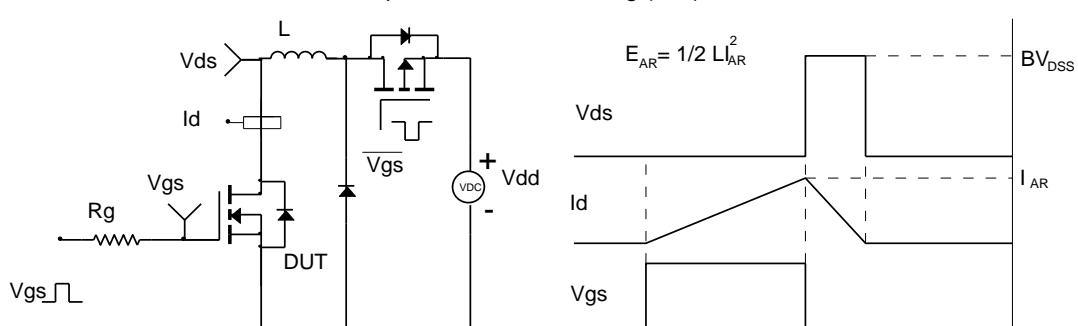
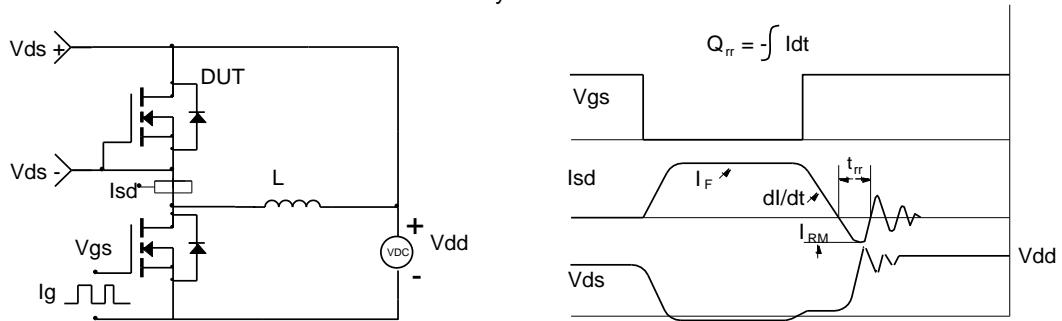


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Gate Charge Test Circuit & Waveform**Resistive Switching Test Circuit & Waveforms****Unclamped Inductive Switching (UIS) Test Circuit & Waveforms****Diode Recovery Test Circuit & Waveforms**

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